



Click [here](#) for the 3D model.

General Information

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| Series | SMD Comm COG HV Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, FT-CAP, Ultra-Stable |
| Features | FT-CAP, Ultra-Stable |
| RoHS | No |
| Prop 65 | ⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov . |
| Termination | Flexible Termination With Lead (SnPb) |
| Marking | false |
| AEC-Q200 | No |
| Typical Component Weight | 14 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

Dimensions

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|-----------|------------------|
| Chip Size | 0805 |
| L | 2mm +/-0.3mm |
| W | 1.25mm +/-0.3mm |
| T | 1.25mm +/-0.15mm |
| S | 0.6mm MIN |
| B | 0.5mm +/-0.25mm |

Packaging Specifications

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|--------------------|--------------------------|
| Packaging | T&R, 330mm, Plastic Tape |
| Packaging Quantity | 10000 |

Specifications

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|--|---------------------------|
| Capacitance | 20 pF |
| Measurement Condition | 1MHz 1.0Vrms |
| Capacitance Tolerance | 20% |
| Voltage DC | 1000 VDC |
| Dielectric Withstanding Voltage | 1200 VDC |
| Temperature Range | -55/+125°C |
| Temperature Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1MegaHz 1.0Vrms |
| Dissipation Factor | 0.1% 1MHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

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